Vishay Siliconix

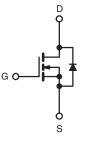


E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.158				
Q _g max. (nC)	95					
Q _{gs} (nC)	16					
Q _{gd} (nC)	25					
Configuration	Single					

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB23N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	less otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	600	v		
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Durain Current (T. 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D -	23	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		15	А
Pulsed Drain Current ^a		I _{DM}	63		
Linear Derating Factor		1.8	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	353	mJ
Maximum Power Dissipation	PD	227	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	125 °C	dV/dt	37)//mm	
Reverse Diode dV/dt ^d			34	V/ns	
Soldering Recommendations (Peak Temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 5$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.				
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Maximum Junction-to-Case (Drain)	R _{thJC}	-		0.55		°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT		
Static		_						ļ
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	V _{GS} = 0 V, I _D = 250 μA		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$. 5	I _D = 1 mA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D =	-	2	-	4	V
	V GS(th)		$V_{GS} = \pm 20$		-	_	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	_	±1	μA
			= 600 V, V ₀		_	_	1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}			√, TJ = 125 °C	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		_D = 12 A	-	0.132	0.158	Ω
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D	= 12 A	-	6.4	-	S
Dynamic		-						<u> </u>
Input Capacitance	C _{iss}		V _{GS} = 0 \	/	-	2418	-	Τ
Output Capacitance	C _{oss}		$V_{GS} = 0 V,$ $V_{DS} = 100 V,$		-	119	-	1
Reverse Transfer Capacitance	C _{rss}		f = 1 MH	Z	-	4	-	1
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	107	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	- V _{DS} = 0 V			-	320	-	
Total Gate Charge	Qg				-	63	95	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 12	A, V _{DS} = 480 V	-	16	-	
Gate-Drain Charge	Q _{gd}				-	25	-	
Turn-On Delay Time	t _{d(on)}				-	22	44	
Rise Time	t _r		= 480 V, I _D		-	38	76	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	66	99	ns
Fall Time	t _f	1		-	34	68	1	
Gate Input Resistance	Rg	f = 1	f = 1 MHz, open drain		-	0.73	-	Ω
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	
Pulsed Diode Forward Current	I _{SM}	-			-	-	63	- A
Diode Forward Voltage	V _{SD}	T _{.1} = 25 °C	C, I _S = 12 /	A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	0	~		-	384	768	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$			6.4	12.8	μC
Reverse Recovery Current	I _{RRM}	di/dt =	$dl/dt = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{R}} = 25 \text{ V}$		-	30		A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

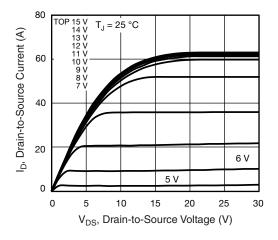


Fig. 1 - Typical Output Characteristics

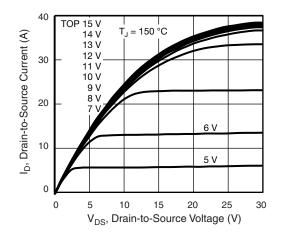
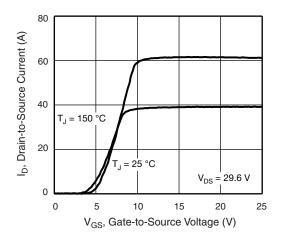


Fig. 2 - Typical Output Characteristics





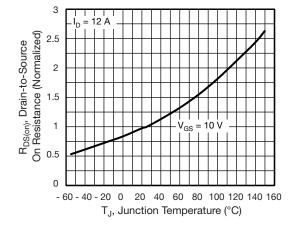


Fig. 4 - Normalized On-Resistance vs. Temperature

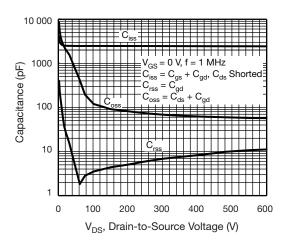


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

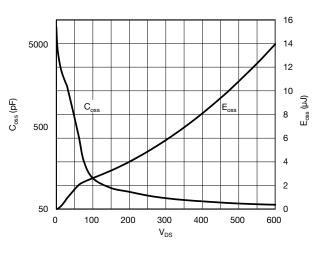


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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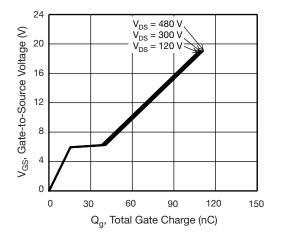


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

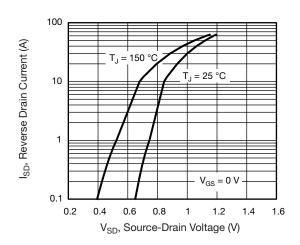


Fig. 8 - Typical Source-Drain Diode Forward Voltage

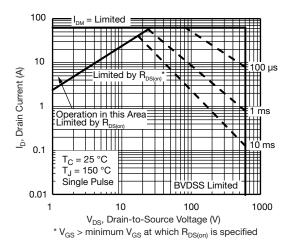


Fig. 9 - Maximum Safe Operating Area

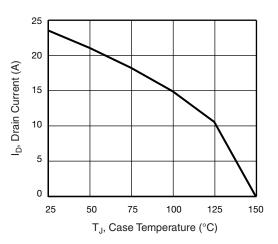


Fig. 10 - Maximum Drain Current vs. Case Temperature

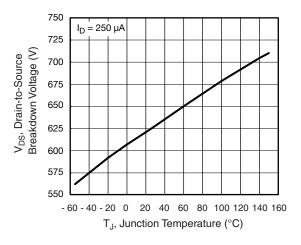
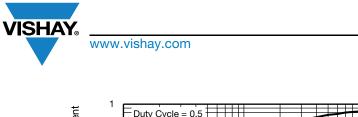
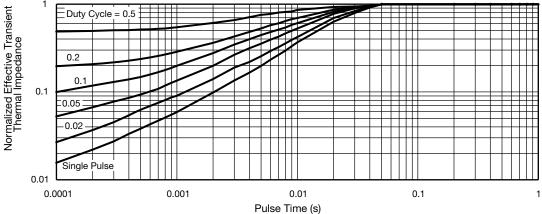


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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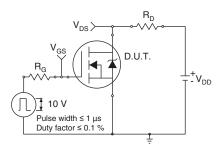


Fig. 13 - Switching Time Test Circuit

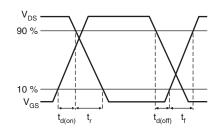


Fig. 14 - Switching Time Waveforms

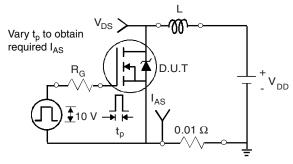


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

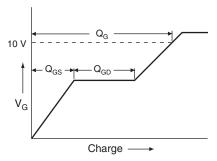
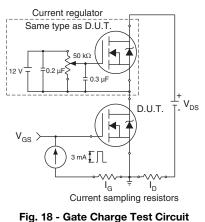


Fig. 17 - Basic Gate Charge Waveform



1. 18 - Gate Charge Test Circuit

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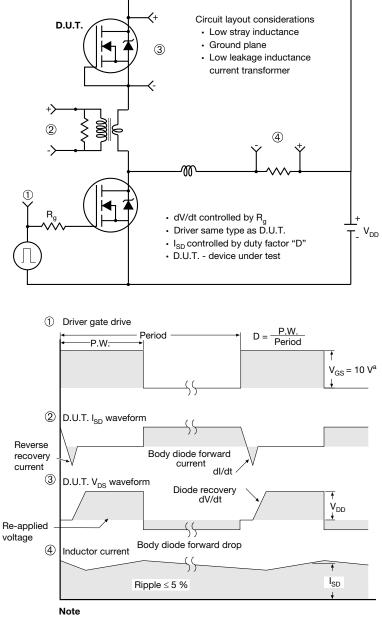
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SHAY

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91552.

H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>		
	MILLIN	IETERS	INCHES				MILLIN	IETERS	INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
				0.010		F		10.07	0.000	0.420	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120	
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-	
							6.22	- 10.67 - BSC	0.245	- BSC	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625	
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110	
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066	
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070	

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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